# International Rectifier

## IRF7311PbF

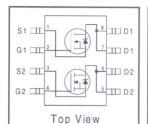
HEXFET® Power MOSFET

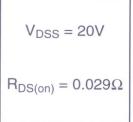
- Generation V Technology
- Ultra Low On-Resistance
- Dual N-Channel MOSFET
- Surface Mount
- Fully Avalanche Rated
- Lead-Free

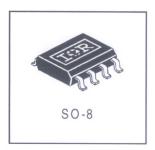
#### Description

Fifth Generation HEXFETs from International Rectifier utilize advanced processing techniques to achieve extremely low on-resistance per silicon area. This benefit, combined with the fast switching speed and ruggedized device design that HEXFET Power MOSFETs are well known for, provides the designer with an extremely efficient and reliable device for use in a wide variety of applications.

The SO-8 has been modified through a customized leadframe for enhanced thermal characteristics and multiple-die capability making it ideal in a variety of power applications. With these improvements, multiple devices can be used in an application with dramatically reduced board space. The package is designed for vapor phase, infra red, or wave soldering techniques.







#### Absolute Maximum Ratings ( T<sub>A</sub> = 25°C Unless Otherwise Noted)

		Symbol	Maximum	Units	
Drain-Source Voltage		V <sub>DS</sub>	20	V	
Gate-Source Voltage		V <sub>GS</sub>	± 12		
Continuous Drain Current®	T <sub>A</sub> = 25°C	1	6.6	A	
	T <sub>A</sub> = 70°C	I <sub>D</sub>	5.3		
Pulsed Drain Current		I <sub>DM</sub>	26	_ ^	
Continuous Source Current (Diode Conduction)		Is	2.5		
Maximum Power Dissipation ⑤	$T_A = 25^{\circ}C$	D	2.0	10/	
	T <sub>A</sub> = 70°C	P <sub>D</sub>	1.3	W	
Single Pulse Avalanche Energy ②		E <sub>AS</sub>	100	mJ	
Avalanche Current		I <sub>AR</sub>	4.1	A	
Repetitive Avalanche Energy		E <sub>AR</sub>	0.20	mJ	
Peak Diode Recovery dv/dt ③		dv/dt	5.0	V/ ns	
Junction and Storage Temperature Range		$T_{J_i}T_{STG}$	-55 to + 150	°℃	

#### **Thermal Resistance Ratings**

Parameter	Symbol	Limit	Units
Maximum Junction-to-Ambient®	R <sub>0JA</sub>	62.5	°C/W

Electrical Characteristics @ T<sub>J</sub> = 25°C (unless otherwise specified)

	Parameter	Min.	Тур.	Max.	Units	Conditions
V <sub>(BR)DSS</sub>	Drain-to-Source Breakdown Voltage	20		_	V	$V_{GS} = 0V, I_D = 250\mu A$
$\Delta V_{(BR)DSS}/\Delta T_J$	Breakdown Voltage Temp. Coefficient	_	0.027	_	V/°C	Reference to 25°C, I <sub>D</sub> = 1mA
R <sub>DS(on)</sub>	Static Drain-to-Source On-Resistance		0.023	0.029	Ω	V <sub>GS</sub> = 4.5V, I <sub>D</sub> = 6.0A ④
			0.030	0.046		V <sub>GS</sub> = 2.7V, I <sub>D</sub> = 5.2A ④
V <sub>GS(th)</sub>	Gate Threshold Voltage	0.7			٧	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$
9fs	Forward Transconductance	_	20	_	S	$V_{DS} = 10V, I_D = 6.0A$
I <sub>DSS</sub>	Drain-to-Source Leakage Current			1.0	μА	V <sub>DS</sub> = 16V, V <sub>GS</sub> = 0V
				5.0		$V_{DS} = 16V, V_{GS} = 0V, T_{J} = 55^{\circ}C$
I <sub>GSS</sub>	Gate-to-Source Forward Leakage			100	nA	V <sub>GS</sub> = 12V
	Gate-to-Source Reverse Leakage	_	_	-100	nA	V <sub>GS</sub> = -12V
$Q_g$	Total Gate Charge	_	18	27		$I_D = 6.0A$
Qgs	Gate-to-Source Charge	-	2.2	3.3	nC	$V_{DS} = 10V$
Q <sub>gd</sub>	Gate-to-Drain ("Miller") Charge		6.2	9.3		V <sub>GS</sub> = 4.5V, See Fig. 10 ④
t <sub>d(on)</sub>	Turn-On Delay Time		8.1	12		$V_{DD} = 10V$
t <sub>r</sub>	Rise Time		17	25		$I_D = 1.0A$
t <sub>d(off)</sub>	Turn-Off Delay Time		38	57	ns	$R_G = 6.0\Omega$
t <sub>f</sub>	Fall Time		31	47		$R_D = 10\Omega$ ④
C <sub>iss</sub>	Input Capacitance		900			$V_{GS} = 0V$
Coss	Output Capacitance		430		pF	V <sub>DS</sub> = 15V
C <sub>rss</sub>	Reverse Transfer Capacitance		200			f = 1.0MHz, See Fig. 9

#### Source-Drain Ratings and Characteristics

	Parameter	Min.	Тур.	Max.	Units	Conditions
Is	Continuous Source Current (Body Diode)	_	_	2.5		MOSFET symbol showing the
I <sub>SM</sub>	Pulsed Source Current (Body Diode) ①	_	_	26	A	integral reverse p-n junction diode.
$V_{SD}$	Diode Forward Voltage		0.72	1.0	V	$T_J = 25^{\circ}C$ , $I_S = 1.7A$ , $V_{GS} = 0V$ ③
t <sub>rr</sub>	Reverse Recovery Time	_	52	77	ns	$T_J = 25^{\circ}C, I_F = 1.7A$
Q <sub>rr</sub>	Reverse RecoveryCharge	_	58	86	nC	di/dt = 100A/μs ③

#### Notes:

- Repetitive rating; pulse width limited by max. junction temperature. ( See fig. 11 )
- $\label{eq:starting} \begin{array}{ll} \text{ Starting T}_J = 25^{\circ}\text{C}, \ L = 12\text{mH} \\ \text{R}_G = 25\Omega, \ \text{I}_{AS} = 4.1\text{A}. \end{array}$
- $\label{eq:loss_def} \begin{array}{l} \text{ $\mathbb{S}$ I_{SD} \leq 4.1A$, $di/dt \leq 92A/\mu s$, $V_{DD} \leq V_{(BR)DSS}$,} \\ \text{ $T_J \leq 150^{\circ}C$} \end{array}$
- 4 Pulse width  $\leq 300 \mu s$ ; duty cycle  $\leq 2\%$ .
- © Surface mounted on 1 in square Cu board

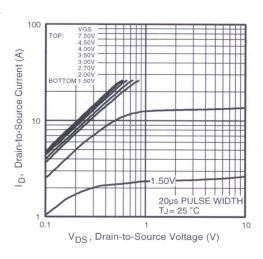


Fig 1. Typical Output Characteristics

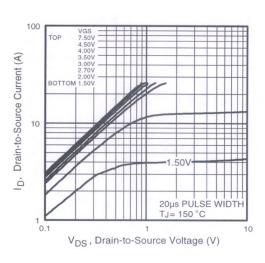


Fig 2. Typical Output Characteristics

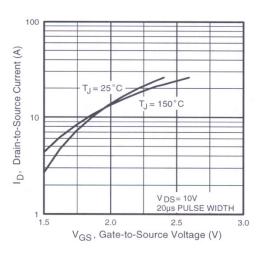


Fig 3. Typical Transfer Characteristics

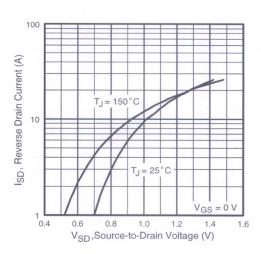
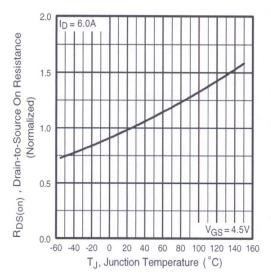


Fig 4. Typical Source-Drain Diode Forward Voltage



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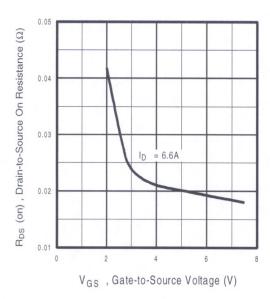
V GS = 2.7V

V GS = 4.5V

ID, Drain Current (A)

Fig 5. Normalized On-Resistance Vs. Temperature

Fig 6. Typical On-Resistance Vs. Drain Current





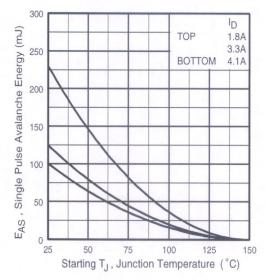


Fig 8. Maximum Avalanche Energy Vs. Drain Current

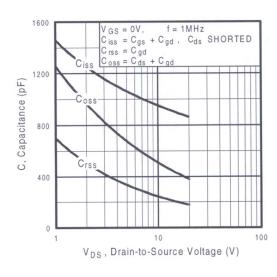


Fig 9. Typical Capacitance Vs. Drain-to-Source Voltage

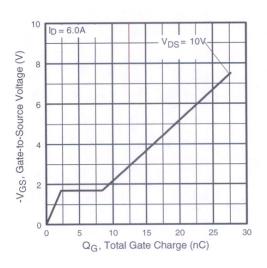


Fig 10. Typical Gate Charge Vs. Gate-to-Source Voltage

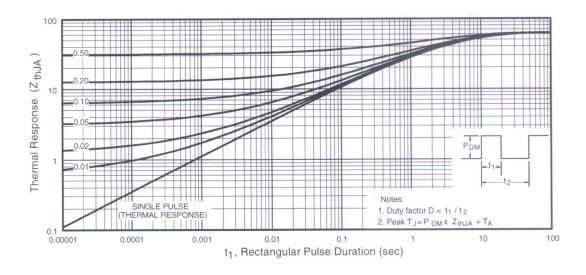


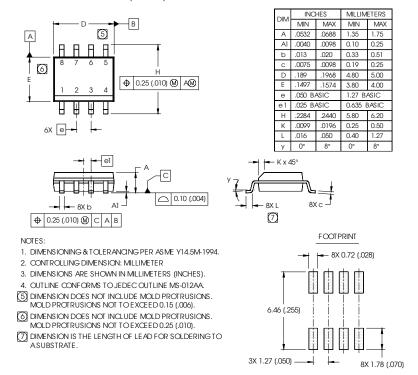
Fig 11. Maximum Effective Transient Thermal Impedance, Junction-to-Ambient

International

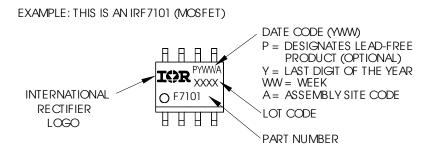
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### SO-8 Package Outline

Dimensions are shown in milimeters (inches)

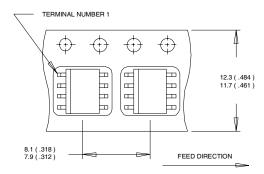


### SO-8 Part Marking Information (Lead-Free)



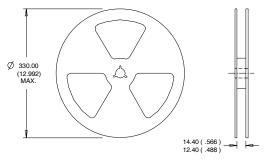
### SO-8 Tape and Reel

Dimensions are shown in milimeters (inches)



#### NOTES:

- CONTROLLING DIMENSION: MILLIMETER.
  ALL DIMENSIONS ARE SHOWN IN MILLIMETERS(INCHES).
  OUTLINE CONFORMS TO EIA-481 & EIA-541.



- NOTES:
  1. CONTROLLING DIMENSION: MILLIMETER.
  2. OUTLINE CONFORMS TO EIA-481 & EIA-541.

Data and specifications subject to change without notice. This product has been designed and qualified for the consumer market. Qualification Standards can be found on IR's Web site.



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